

**SURFACE MOUNT
GLASS PASSIVATED
BRIDGE RECTIFIERS**

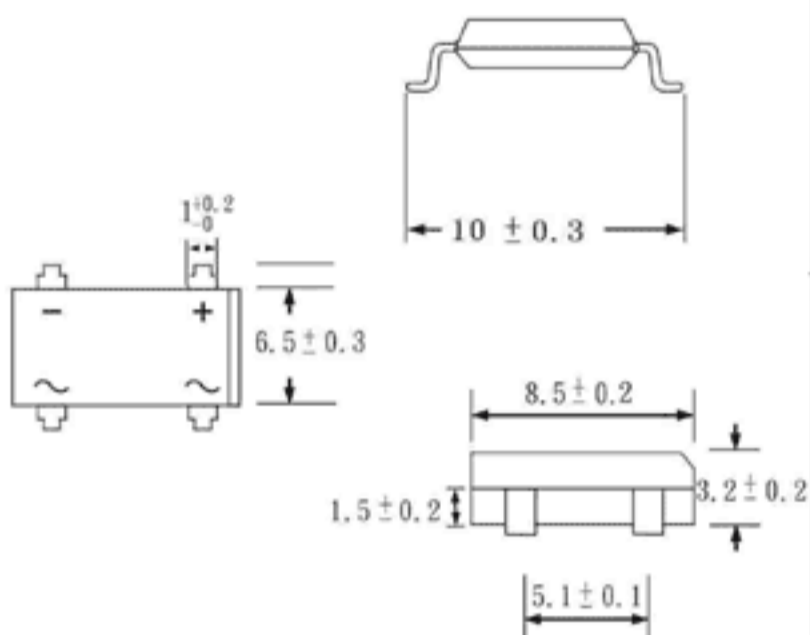
REVERSE VOLTAGE - 50 to 1000 Volts
FORWARD CURRENT - 1.0 Amperes

FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Low forward voltage drop, high current capability
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- Lead tin Pb/Sn copper
- The plastic material has UL flammability classification 94V-0

MECHANICAL DATA

- Polarity: As marked on Body
- Weight: 0.02 ounces, 0.38 grams
- Mounting position: Any


MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

CHARACTERISTICS	SYMBOL	DF005S	DF01S	DF02S	DF04S	DF06S	DF08S	DF10S	UNIT
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @T _A =40°C	I _(AV)	1.0							A
Peak Forward Surge Current 8.3ms single half sine-wave super imposed on rated load (JEDEC Method)	I _{FSM}	50							A
Maximum Forward Voltage at 1.0A DC	V _F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage @T _J = 25 °C @T _J =125°C	I _R	10 500							uA
I ² t Rating for fusing (t<8.3ms)	I ² t	10.4							A ² S
Typical Junction Capacitance per element (Note 1)	C _J	25							pF
Typical Thermal Resistance (Note 2)	R _{θJA}	40							°C/W
Operating Temperature Range	T _J	-55 to +150							°C
Storage Temperature Range	T _{STG}	-55 to +150							°C

NOTES: 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

2. Thermal resistance from junction to ambient mounted on P.C.B.
with 0.5 x 0.5" (13 x 13mm) copper pads.